International Rectifier

Automotive Grade AUIRS2004S

HALF-BRIDGE DRIVER IC

Features

- · Floating channel designed for bootstrap operation
- Fully operational to +200 V
- Tolerant to negative transient voltage dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout
- 3.3 V, 5 V, and 15 V logic compatible
- Cross-conduction prevention logic
- · Internally set deadtime
- High-side output in phase with input
- Shutdown input turns off both channels
- Matched propagation delay for both channels
- RoHS Compliant
- Automotive qualified*

Typical Applications

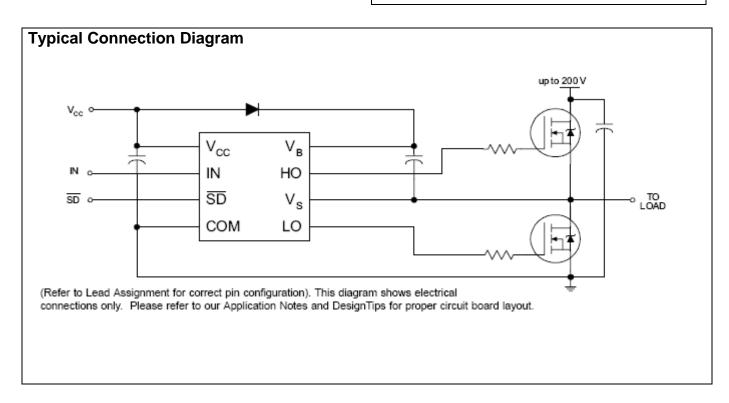
- Motor/Pump Drives
- DC-DC Converters

Product Summary

| V _{OFFSET} | ≤ 200V |
|--|---------------|
| V _{OUT} | 10 – 20V |
| I _{o+} & I _{o-} (typical) | 130mA & 270mA |
| t _{ON} & t _{OFF} (typical) | 680 ns/150 ns |
| Deadtime (typical) | 520 ns |

Package Options





AUIRS2004S



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AUIRS2004S



Description

The AUIRS2004S is a high voltage, high speed power MOSFET and IGBT driver with dependent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive N-channel power MOSFET or IGBT in the high side configuration which operates from 10V to 200 volts.



Qualification Information[†]

| Qualification Level | | Automotive (per AEC-Q100 ^{††}) | | | |
|----------------------------|------------------|---|--|--|--|
| | | Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level. | | | |
| Moisture Sensitivity Level | | MSL3 ^{†††} 260°C (per IPC/JEDEC J-STD-020) | | | |
| | Machine Model | Class M2 (+/-200V) (per AEC-Q100-003) | | | |
| ESD | Human Body Model | Class H1C (+/-2000V) (per AEC-Q100-002) | | | |
| Charged Device Model | | Class C4 (+/-1000V) (per AEC-Q100-011) | | | |
| IC Latch-Up Test | | Class II, Level B †††† (per AEC-Q100-004) | | | |
| RoHS Compliant | | Yes | | | |

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- †† Exceptions to AEC-Q100 requirements are noted in the qualification report.
- ††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.
- †††† LIN and HIN stressed to +/-20mA



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which permanent damage to the device may occur. These are stress ratings only, functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Condition" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Min. | Max. | Units |
|---------------------|---|----------------------|-----------------------|-------|
| V_{B} | High Side Floating Supply Voltage | -0.3 | 225 | |
| Vs | High Side Floating Offset Voltage | V _B - 20 | V _B + 0.3 | |
| V_{HO} | High Side Floating Output Voltage | V _S - 0.3 | V _B + 0.3 | |
| V _{CC} | Low Side and Logic Fixed Supply Voltage | -0.3 | 25 | |
| V_{LO} | Low Side Output Voltage | -0.3 | V _{CC} + 0.3 | V |
| V _{IN} | Logic Input Voltage (IN, SD) | V _{SS} -0.3 | V _{cc} + 0.3 | |
| dV _S /dt | Allowable Offset Supply Voltage Transient | | 50 | V/ns |
| P _D | Package Power Dissipation @ TA ≤ +25 °C | _ | 0.625 | W |
| Rth _{JA} | Thermal Resistance, Junction to Ambient | _ | 200 | °C/W |
| T_J | Junction Temperature | | 150 | |
| Ts | Storage Temperature | -55 | 150 | °C |
| T _L | Lead Temperature (soldering, 10 seconds) | | 300 | |

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. All voltage parameters are absolute voltage referenced to COM. The V_S offset rating is tested with all supplies biased at 15 V differential.

| Symbol | Definition | Min. | Max. | Units |
|-----------------|--|--------------------|--------------------|-------|
| V _B | High Side Floating Supply Voltage | V _S +10 | V _S +20 | |
| Vs | Static High side floating offset voltage | Note1 | 200 | |
| V_{HO} | High Side Floating Output Voltage | Vs | V_B | |
| V _{CC} | Low Side and Logic Fixed Supply Voltage | 10 | 20 | V |
| V_{LO} | Low Side Output Voltage | 0 | V _{CC} | |
| V_{IN} | Logic Input Voltage (IN & SD) | 0 | V _{CC} | |
| T _A | Ambient temperature | -40 | 125 | °C |

Note 1: Logic operational for V_S of -5 V to +200 V. Logic state held for V_S of -5 V to $-V_{BS}$.



Dynamic Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C \leq Tj \leq 125°C with bias conditions of V_{BIAS} (V_{CC}, V_{BS}) = 15 V, C_L = 1000 pF.

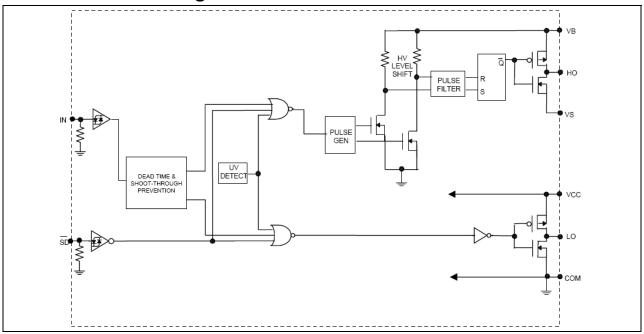
| Symbol | Definition | Min | Тур | Max | Units | Test Conditions |
|------------------|---|-----|-----|-----|-------|------------------------|
| t _{on} | Turn-on propagation delay | | 680 | 880 | | V _S = 0 V |
| t _{off} | Turn-off propagation delay | | 150 | 220 | | V _S = 200 V |
| t _r | Turn-on rise time | _ | 160 | 220 | | |
| t _f | Turn-off fall time | _ | 70 | 170 | | |
| DT ₂₅ | Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off | 400 | 520 | 650 | ns | Tj=25^C |
| DT | Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off | 400 | | 800 | | |
| MT ₂₅ | Delay matching HS & LS turn-on/off | _ | _ | 80 | | Tj=25^C |
| MT | Delay matching HS & LS turn-on/off | | _ | 150 | | |

Static Electrical Characteristics

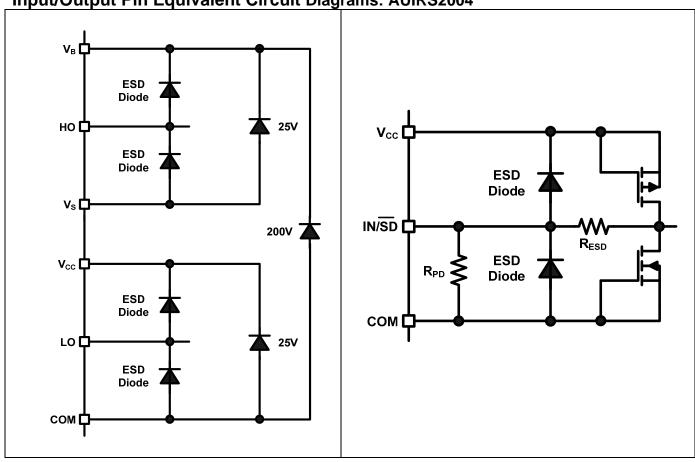
Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C \leq Tj \leq 125°C with bias conditions of V_{BIAS} (V_{CC} , V_{BS}) = 15 V. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

| Symbol | Definition | | Тур | Max | Units | Test Conditions |
|---------------------|---|--|------|-----|-------------------------------|---|
| V _{IH} | Logic "1" (HO) & Logic "0" (LO) input Voltage | 2.5 | _ | | | |
| V _{IL} | Logic "0" (HO) & Logic "1" (LO) input Voltage | | _ | 0.8 | | V _{CC} = 10 V to 20 V |
| $V_{SD,TH+}$ | SD Input Positive Going Threshold | 2.5 | | | ., | V _{CC} = 10 V to 20 V |
| V _{SD,TH-} | SD Input Negative Going Threshold | | | 0.8 | V | |
| V _{OH} | High Level Output Voltage, V _{BIAS} - V _O | _ | 0.05 | 0.2 | | I _O = 2 mA |
| V _{OL} | Low Level Output Voltage, V _O | _ | 0.02 | 0.1 | | 1 ₀ – 2 IIIA |
| I _{LK} | Offset Supply Leakage Current | _ | | 50 | | V _B = V _S = 200 V |
| I_{QBS} | Quiescent V _{BS} Supply Current | _ | 30 | 55 | | \/ - 0\/ or 5\/ |
| I _{QCC} | Quiescent V _{CC} Supply Current | V _{CC} Supply Current — 150 270 | | | $V_{IN} = 0 \text{ V or 5 V}$ | |
| I _{IN+} | Logic "1" Input Bias Current | | 3 | 10 | μA | V _{IN} = 5 V |
| I _{IN-} | Logic "0" Input Bias Current | | | 5 | | V _{IN} = 0 V |
| I _{SD+} | Bias Current at SD pin, shut down disabled | | 3 | 10 | | SD pin = 5 V |
| I_{SD-} | Bias Current at SD pin, shut down enabled | | | 5 | | SD pin = 0 V |
| V _{CCUV+} | V _{CC} Supply Undervoltage Positive going Threshold | 8 | 8.9 | 9.8 | V | |
| V _{CCUV-} | V _{CC} Supply Undervoltage Negative Going Threshold | 7.4 | 8.2 | 9 | V | |
| I _{O+} | Output High Short Circuit Pulsed Current | 130 | 290 | | mA | $V_O = 0 V$, PW $\leq 10 us$ |
| I _{O-} | Output Low Short Circuit Pulsed Current | 270 | 600 | | шА | V _O = 15 V, PW ≤ 10 us |

Functional Block Diagram



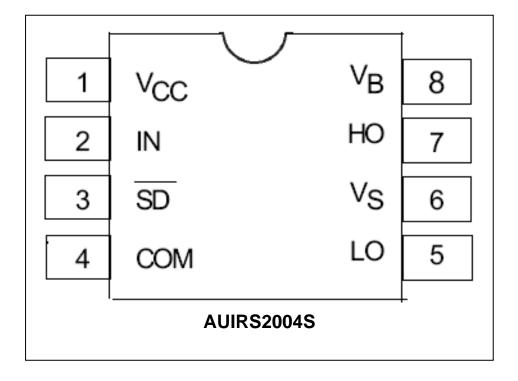
Input/Output Pin Equivalent Circuit Diagrams: AUIRS2004



Lead Definitions

| Symbol | Description |
|-----------------|--|
| IN | Logic input for high side and low side gate driver outputs (HO and LO), in phase with HO |
| SD | Logic input for shutdown |
| V_B | High side floating supply |
| НО | High side gate drive output |
| Vs | High side floating supply return |
| V _{CC} | Low side and logic fixed supply |
| LO | Low side gate drive output |
| COM | Low side return |

Lead Assignments



Application Information and Additional Details

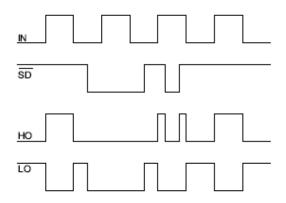


Figure 1: Input/Output Timing Diagram

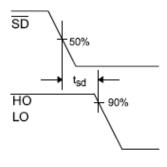


Figure3: Shutdown Waveform Definitions

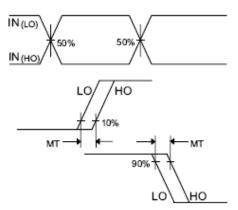


Figure 5: Delay Matching Waveform Definitions

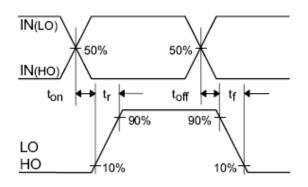


Figure 2: Switching Time Waveform Definitions

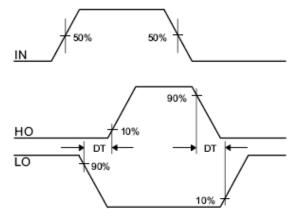
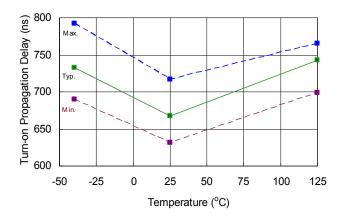


Figure 4: Deadtime Waveform Definitions



Parameter Temperature Trends

Figures illustrated in this chapter provide information on the experimental performance of the AUIRS2004S HVIC. The line plotted in each figure is generated from actual lab data. A large number of individual samples were tested at three temperatures (-40 °C, 25 °C, and 125 °C) in order to generate the experimental curve. The line consists of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the Typ. curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).



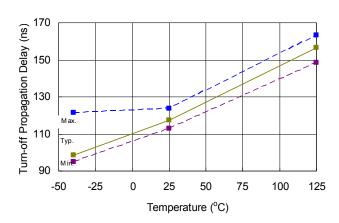
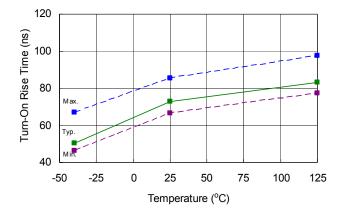


Figure 6: Ton vs. temperature

Figure 7: T_{OFF} vs. temperature



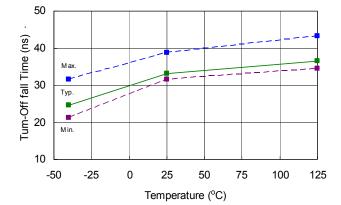


Figure 8: T_R vs. temperature

Figure 9: T_F vs. temperature

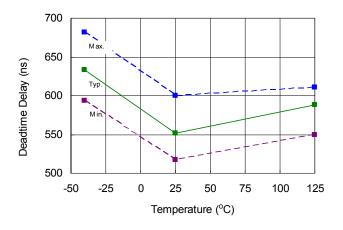


Figure 10: Deadtime vs. temperature

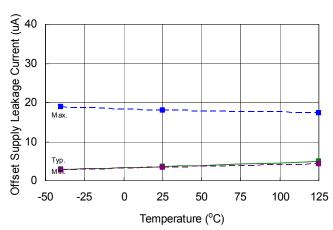


Figure 11: Offset Leakage Current vs. temperature

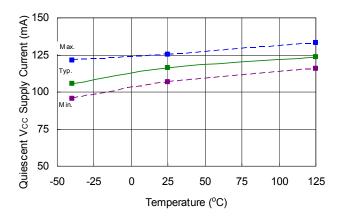


Figure 12: V_{CC} Supply Current vs. Temperature

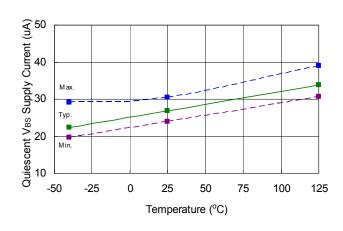


Figure 13: V_{BS} Supply Current vs. temperature

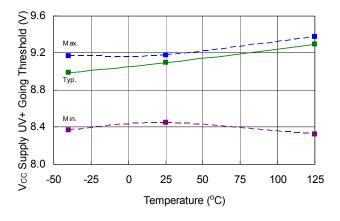


Figure 14: V_{CCUV+} vs. temperature

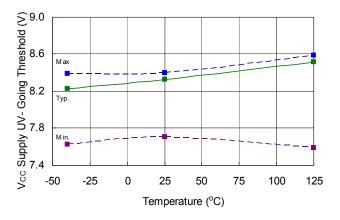
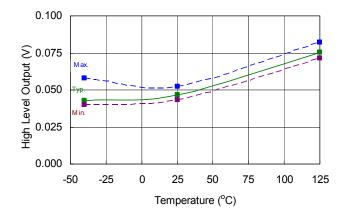


Figure 15: V_{CCUV}. vs. temperature



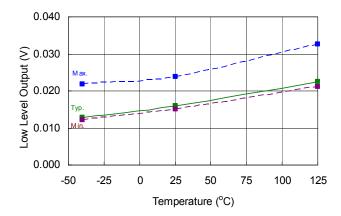
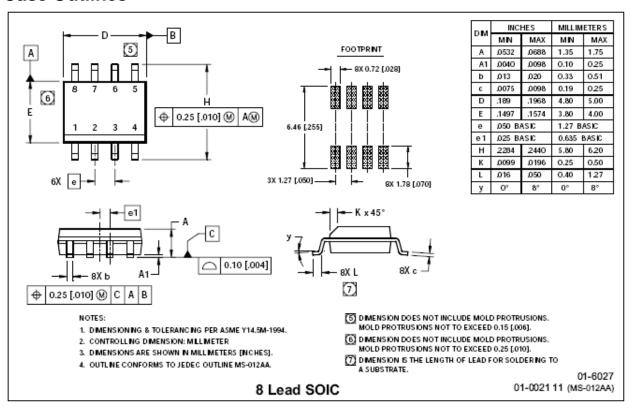


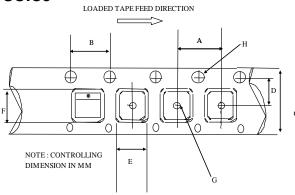
Figure 16: V_{OH} ($I_O = 2mA$) vs. temperature

Figure 17: V_{OL} ($I_O = 2mA$) vs. temperature

Case Outlines

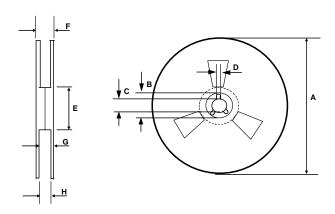


Tape and Reel Details: SOIC8



CARRIER TAPE DIMENSION FOR 44PLCC

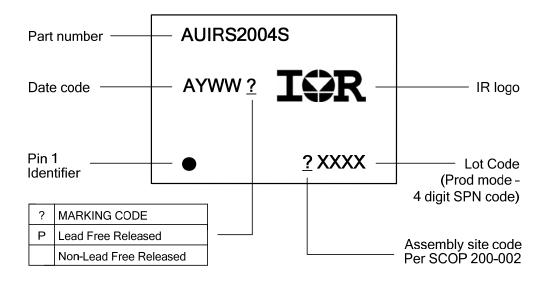
| | Metric | | Imp | erial |
|------|--------|-------|-------|-------|
| Code | Min | Max | Min | Max |
| Α | 23.90 | 24.10 | 0.94 | 0.948 |
| В | 3.90 | 4.10 | 0.153 | 0.161 |
| С | 31.70 | 32.30 | 1.248 | 1.271 |
| D | 14.10 | 14.30 | 0.555 | 0.562 |
| E | 17.90 | 18.10 | 0.704 | 0.712 |
| F | 17.90 | 18.10 | 0.704 | 0.712 |
| G | 2.00 | n/a | 0.078 | n/a |
| Н | 1.50 | 1.60 | 0.059 | 0.062 |



REEL DIMENSIONS FOR 44PLCC

| | Me | tric | lmp | erial |
|------|--------|--------|--------|--------|
| Code | Min | Max | Min | Max |
| Α | 329.60 | 330.25 | 12.976 | 13.001 |
| В | 20.95 | 21.45 | 0.824 | 0.844 |
| С | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| E | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 38.4 | n/a | 1.511 |
| G | 34.7 | 35.8 | 1.366 | 1.409 |
| Н | 32.6 | 33.1 | 1.283 | 1.303 |

Part Marking Information



Ordering Information

| Daga Dant Manulage | Danks as True | Standard Pack | | Commission Bout Name on |
|--------------------|----------------|---------------|----------|-------------------------|
| Base Part Number | Package Type | Form | Quantity | Complete Part Number |
| AUIRS2004S | SOIC8 | Tube/Bulk | 95 | AUIRS2004S |
| A011\320043 | IRS2004S 501C8 | | 2500 | AUIRS2004STR |



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WORLD HEADQUARTERS:

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Revision History

| Date | Comment |
|---------------|--|
| Jul. 30, 2010 | Converted from industrial datasheet |
| Aug. 30, 2010 | Update qualification ESD/LU class |
| Aug. 31, 2010 | Changed Deadtime typical to 700nS on 1 st page, TON max to 880, MT max to 150, 60, DT min to 400, typ to 600. Added tri-temp graph, I/O equivalent circuit. Modified block diagram, SD pull up now. |
| Sep. 19, 2010 | Typ Deadtime back to 520ns; DTmax=650ns at 25^C; DTmax=800ns; MT max to 150ns, (60ns at 25^C). ISD+ and ISD- parameters added to specify SD input impedance. |
| Sep. 28, 2010 | Updated MT ₂₅ to 80; updated block diagram and SD pin I/O circuit |
| Sep. 30, 2010 | ISD+ and ISD- parameters exchanged because SD is pull down. |
| Oct. 14, 2010 | Typ application section filled up |
| Oct. 19, 2010 | Update reflow temp to 260C |
| Nov. 2, 2010 | Changed 1 st page header. Minor update characteristics table format and corrected SD pin lead definition |